Application Data Sheet

Application Information

Application number:: Not Yet Assigned

Application Type:: Regular

Subject Matter:: Utility
Suggested Group Art Unit:: N/A

CD-ROM or CD-R?:: None

Sequence submission?:: Paper

Computer Readable Form (CRF)?:: No

Title:: PRINTED CIRCUIT BOARD AND METHOD

MANUFACTURING THE SAME

Attorney Docket Number:: 356972020512

Request for Early Publication?:: No

Request for Non-Publication?:: Yes

Small Entity?:: No

Petition included?:: No

Secrecy Order in Parent Appl.?:: No

Applicant Information

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Status:: Full Capacity

Given Name:: Seiichi

Family Name:: NAKATANI

City of Residence:: Hirakata-shi

Country of Residence:: Japan

Street of mailing address:: 11-29-16, Kourigaoka

City of mailing address:: Hirakata-shi

State or Province of mailing address:: Osaka

Country of mailing address:: Japan

Postal or Zip Code of mailing address:: 573-0085

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Japan

Status::

Full Capacity

Given Name::

Kouichi

Family Name::

HIRANO

City of Residence::

Hirakata-shi

Country of Residence::

Japan

Street of mailing address::

2-9-15-612, Makinosaka

City of mailing address::

Hirakata-shi

State or Province of mailing address::

Osaka

Country of mailing address::

Japan

Postal or Zip Code of mailing address::

573-1146

Correspondence Information

Correspondence Customer Number::

25227

Representative Information

Representative Customer Number::

25227

Continuity Information

This application is a:

DIVISION

> Application One:

09/956,551

Filing Date:

September 20, 2001

which is a:

DIVISION

>>Application Two:

09/484,899

Filing Date:

January 18, 2000

which is a:

DIVISION

>>>Application Three:

09/196,792

Filing Date:

November 20, 1998

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Initial 06/24/03

Prior Foreign Applications

Foreign Application: 9-322595

Filing Date: November 20, 1997

Country: Japan

Priority Claimed: Yes

Assignee Information

Assignee name:: Matsushita Electric Industrial Co., Ltd.

Assignee Mailing Address:: 1006-banchi, Oaza-Kadoma,

City of mailing address:: Kadoma-shi

State or Province of mailing address:: Osaka

Postal or Zip Code of mailing address:: 571-8501

Country of mailing address:: Japan

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